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## <u>CLAIMS</u>

## What is claimed is:

1	Λn	integrated	circuit	etmichire	comprising:
1.	$\Delta$ II	micgialcu	CIICUIL	Structure,	comprising.

- NMOS and PMOS transistors, at least some of said PMOS transistors being formed in N-well diffusions in a semiconductor material; and
- a blanket P-type diffusion component having a peak concentration depth more than twice that of said p-well.
  - 2. An integrated circuit structure, comprising:
    - a first population of a first dopant in a semiconductor, said first population occupying a first region of said semiconductor;
    - a second population of said first dopant occupying a second region of said semiconductor, said second region being at a deeper implant depth than said first region;
    - a second dopant occupying said second region of said semiconductor;
- wherein said second dopant is of opposite electrical ionization than said first dopant.

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- 3. A fabrication method, comprising the steps of:
  - a) implanting first dopant atoms into a semiconductor body to create a first-conductivity-type well diffusion therein; and
  - b) implanting second dopant atoms into said semiconductor body, with more than twice the stopping distance and less than one-quarter of the dosage per unit area as said step a), to compensate atoms which channeled during said step a).

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